

May 19, 2021

## DIC Corporation

**DIC to Exhibit at the AUTOMOTIVE ENGINEERING EXPOSITION 2021 ONLINE**

*—Exhibit will showcase cutting-edge materials that help reduce vehicle weight and enhance performance—*

**Tokyo, Japan**—DIC today announced that it will exhibit cutting-edge materials for automotive applications at the AUTOMOTIVE ENGINEERING EXPOSITION 2021 ONLINE, which will be held May 26–July 30, 2021.

**Exposition Details**

Dates: May 26–July 30, 2021  
 Venue: Online  
 Official website: <https://aee.expo-info.jsae.or.jp/en/online/>  
 (Currently accepting registrations)



DIC’s online exhibit will showcase a variety of materials for that will help increase the energy efficiency and performance of automobiles today and in the future. These products can be viewed by registered attendees accessing the following URL during the period of the exhibition.

<https://aee.online.jsae.or.jp/en/exhibition/detail.html?id=200>

(Accessible for the duration of the exhibition, beginning from 10:00 am on May 26, 2021)

**Products Exhibited**

Product name	Description	Key performance features
DICARBO® LF	Fast-curable carbon fiber prepreg	Helps reduce weight and lower process costs
CeramNex™	Special Shape alumina filler	Imparts heat-dissipating and insulating properties, strength and designability
TrinDy® and others	Additive Manufacturing Materials (Functional filaments, stereolithography materials)	Facilitate mold-free modelling; customizable, antiviral, thermoplastic, easily processed
DIC.PPS	PPS compounds	Help reduce weight and adds heat and chemical resistance
PEONY®, FUNECON®	Functional compounds/masterbatches for various thermoplastics	Antiviral; deliver high level of jetness; boast flame-resistance, and insulating and heat dissipating properties
DAITAC®	Double-sided industrial-use tapes, adhesive tapes	Excellent outgassing resistance, transparency and durability
TYFORCE®	Environment-friendly reactive hot melt adhesives	Boast superb adhesion to different types of materials; solventless; shorten processing time